



COMPLEMENTARY PAIR ENHANCEMENT MODE MOSFET

Product Summary

Device	BV _{DSS}	R _{DS(ON)} Max	I _D Max T _A = +25°C
		0.99Ω @ $V_{GS} = 4.5V$	450mA
Q1	20V	1.2Ω @ $V_{GS} = 2.5V$	400mA
Qı	200	1.8Ω @ $V_{GS} = 1.8V$	330mA
		2.4Ω @ $V_{GS} = 1.5V$	300mA
		1.9Ω @ V _{GS} = -4.5V	-310mA
Q2	-20V	2.4Ω @ V _{GS} = -2.5V	-280mA
QZ	-20 V	3.4Ω @ $V_{GS} = -1.8V$	-240mA
		5Ω @ $V_{GS} = -1.5V$	-180mA

Description and Applications

This MOSFET is designed to meet the stringent requirements of Automotive applications. It is qualified to AEC-Q101, supported by a PPAP and is ideal for use in:

- General Purpose Interfacing Switch
- Power Management Functions
- Analog Switch





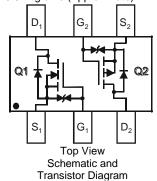
Top View

Features and Benefits

- Low On-Resistance
- Very Low Gate Threshold Voltage, 1.0V Max
- Low Input Capacitance
- Fast Switching Speed
- Ultra-Small Surface Mount Package 1mm x 1mm
- Low Package Profile, 0.45mm Maximum Package Height
- ESD Protected Gate
- Totally Lead-Free & Fully RoHS Compliant (Note 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

Mechanical Data

- Case: SOT963
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
 - Terminal Connections Indicator: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 (23)
- Weight: 0.027 grams (Approximate)



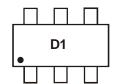
Ordering Information (Note 5)

Part Number	Case	Packaging
DMC2990UDJQ-7	SOT963	10K/Tape & Reel
DMC2990UDJQ-7B	SOT963	10K/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to http://www.diodes.com/product_compliance_definitions.html.
- 5. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



D1 = Product Type Marking Code

DMC2990UDJQ
Document number: DS39168 Rev. 1 - 2



Maximum Ratings Q1 N-CHANNEL (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Drain-Source Voltage		V _{DSS}	20	V	
Gate-Source Voltage	V _{GSS}	±8	V		
Stear Stat		$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	450 350	mA
Continuous Drain Current (Note 6) V _{GS} = 4.5V	t<5s	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	520 410	mA
Continuous Drain Current (Note 6) V _{GS} = 1.8V Steady State t<5s		$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	330 260	mA
		$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	390 310	mA
Maximum Continuous Body Diode Forward Curren	Is	440	mA		
Pulsed Drain Current (Note 7)			I _{DM}	800	mA

Maximum Ratings Q2 P-CHANNEL (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Drain-Source Voltage		V_{DSS}	-20	V	
Gate-Source Voltage			V _{GSS}	±8	V
Continuous Dunis Comment (Note C) V	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	-310 -240	mA
Continuous Drain Current (Note 6) V _{GS} = -4.5V	t<5s	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	-360 -280	mA
		$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	-240 -190	mA
Continuous Drain Current (Note 6) V _{GS} = -1.8V	t<5s	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	-280 -220	mA
Maximum Continuous Body Diode Forward Current	I _S	-440	mA		
Pulsed Drain Current (Note 7)			I _{DM}	-800	mA

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 6)		P _D	350	mW
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	Ĺ.	360	°C/W
Thermal Resistance, Junction to Ambient (Note 6)	t<5s	$R_{\theta JA}$	270	°C/W
Operating and Storage Temperature Range		$T_{J_i}T_{STG}$	-55 to +150	°C

Notes: 6. Device mounted on FR-4 PCB, with minimum recommended pad layout.

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^{7.} Device mounted on minimum recommended pad layout test board, 10µs pulse duty cycle = 1%.



Electrical Characteristics Q1 N-CHANNEL (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)							
Drain-Source Breakdown Voltage	BV _{DSS}	20	-	-	٧	$V_{GS} = 0V, I_D = 250\mu A$	
Zoro Coto Voltago Proin Current @T- 125%		-	-	100	nA	$V_{DS} = 16V, V_{GS} = 0V$	
Zero Gate Voltage Drain Current @T _C = +25°C	DSS	-	-	50		$V_{DS} = 5V$, $V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	-	-	±100	nA	$V_{GS} = \pm 5V$, $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage	V _{GS(TH)}	0.4	-	1.0	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	
		-	0.60	0.99		$V_{GS} = 4.5V, I_D = 100mA$	
		-	0.75	1.2		$V_{GS} = 2.5V, I_D = 50mA$	
Static Drain-Source On-Resistance	R _{DS(ON)}	-	0.90	1.8	Ω	$V_{GS} = 1.8V, I_D = 20mA$	
		-	1.2	2.4		$V_{GS} = 1.5V, I_D = 10mA$	
		-	2.0	-		$V_{GS} = 1.2V, I_D = 1mA$	
Forward Transfer Admittance	Y _{fs}	180	850	-	ms	$V_{DS} = 5V, I_{D} = 125mA$	
Diode Forward Voltage	V _{SD}	-	0.6	1.0	V	V _{GS} = 0V, I _S = 10mA	
DYNAMIC CHARACTERISTICS (Note 9)		•				•	
Input Capacitance	C _{iss}	-	27.6	-	pF	45)/)/ 0)/	
Output Capacitance	Coss	-	4.0	-	pF	$V_{DS} = 15V, V_{GS} = 0V,$ - f = 1.0MHz	
Reverse Transfer Capacitance	Crss	-	2.8	-	pF	- I = 1.0WH2	
Gate Resistance	Rg	-	113	-	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$	
Total Gate Charge	Qq	-	0.5	-	nC	V _{GS} = 4.5V, V _{DS} = 10V.	
Gate-Source Charge	Qgs	-	0.07	-	nC	I _D = 250mA	
Gate-Drain Charge	Q _{gd}	-	0.07	-	nC	1	
Turn-On Delay Time	t _{D(ON)}	-	4.0	_	ns		
Turn-On Rise Time	t _R	-	3.3	-	ns	$V_{DD} = 15V, V_{GS} = 4.5V,$	
Turn-Off Delay Time	t _{D(OFF)}	-	19.0	-	ns	$R_L = 47\Omega$, $R_g = 2\Omega$,	
Turn-Off Fall Time	t _F	-	6.4	-	ns	$I_D = 200 \text{mA}$	

Electrical Characteristics Q2 P-CHANNEL (@T_A = +25°C, unless otherwise specified.)

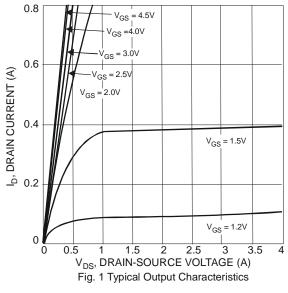
Characteristic		Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)								
Drain-Source Breakdown Voltage		BV _{DSS}	-20	-	-	V	$V_{GS} = 0V, I_D = -250\mu A$	
Zara Cata Valtaga Drain Current	@T _C = +25°C	_	-	1	100	nA	$V_{DS} = -16V, V_{GS} = 0V$	
Zero Gate Voltage Drain Current		I _{DSS}	-	-	50		$V_{DS} = -5V$, $V_{GS} = 0V$	
Gate-Source Leakage		I _{GSS}	-	-	±100	nA	$V_{GS} = \pm 5V$, $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)								
Gate Threshold Voltage		V _{GS(TH)}	-0.4	-	-1.0	V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	
			-	1.2	1.9		$V_{GS} = -4.5V, I_D = -100mA$	
			-	1.5	2.4		$V_{GS} = -2.5V, I_D = -50mA$	
Static Drain-Source On-Resistance		R _{DS(ON)}	-	2.1	3.4	Ω	$V_{GS} = -1.8V, I_{D} = -20mA$	
		, ,	-	2.5	5		$V_{GS} = -1.5V, I_D = -10mA$	
			-	4.0	-		$V_{GS} = -1.2V, I_D = -1mA$	
Forward Transfer Admittance		Y _{fs}	100	450	-	ms	$V_{DS} = -5V, I_{D} = -125mA$	
Diode Forward Voltage	Diode Forward Voltage		-	-0.6	-1.0	V	$V_{GS} = 0V, I_{S} = -10mA$	
DYNAMIC CHARACTERISTICS (Note 9)								
Input Capacitance		C _{iss}	-	28.7	-	рF	151/11/ 01/	
Output Capacitance		Coss	-	4.2	-	рF	$V_{DS} = -15V, V_{GS} = 0V,$ - f = 1.0MHz	
Reverse Transfer Capacitance		C _{rss}	-	2.9	-	pF	1 = 1.0101112	
Gate Resistance		R_g	-	399	-	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$	
Total Gate Charge		Qg	-	0.4	-	nC	V 45V V 40V	
Gate-Source Charge		Q _{qs}	-	0.08	-	nC	$V_{GS} = -4.5V, V_{DS} = -10V,$	
Gate-Drain Charge		Q_{gd}	-	0.06	-	nC	$I_D = -250 \text{mA}$	
Turn-On Delay Time		t _{D(ON)}	-	5.8	-	ns		
Turn-On Rise Time		t _R	-	5.7	-	ns	$V_{DD} = -15V, V_{GS} = -4.5V,$	
Turn-Off Delay Time		t _{D(OFF)}	-	31.1	-	ns	$R_g = 2\Omega, I_D = -200 \text{mA}$	
Turn-Off Fall Time		t _F	-	16.4	-	ns	<u> </u>	

Notes:

- 8. Short duration pulse test used to minimize self-heating effect.
- 9. Guaranteed by design. Not subject to product testing.



Typical Characteristics - N-CHANNEL



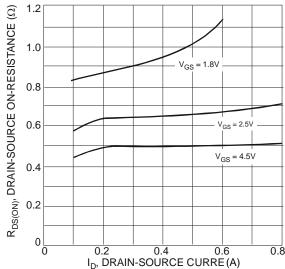


Fig. 3 Typical On-Resistance vs. Drain Current and Gate Voltage

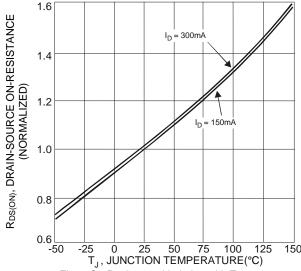
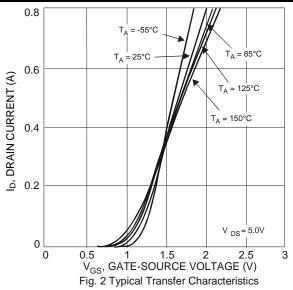


Fig. 5 On-Resistance Variation with Temperature



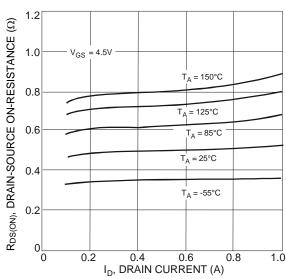


Fig. 4 Typical On-Resistance vs. Drain Current and Temperature

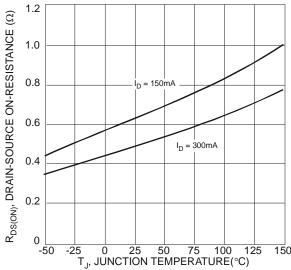


Fig. 6 On-Resistance Variation with Temperature



Typical Characteristics - N-CHANNEL (Cont.)

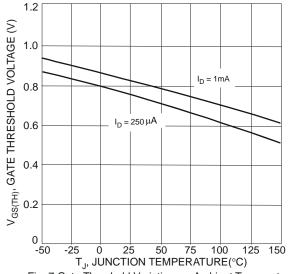
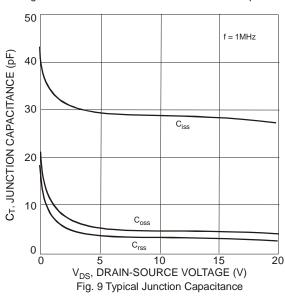
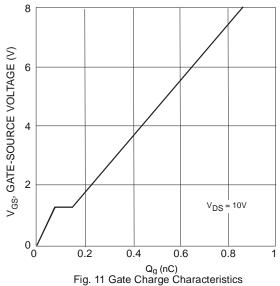
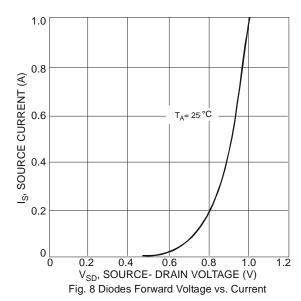
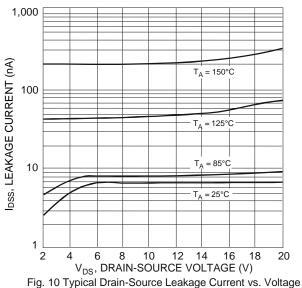


Fig. 7 Gate Threshold Variation vs. Ambient Temperature





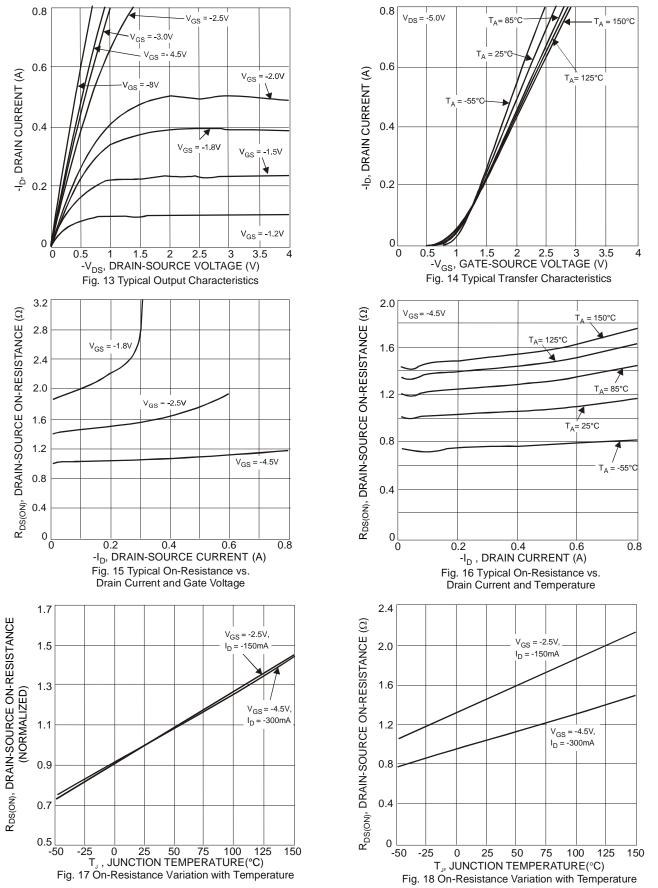




ID, DRAIN CURRENT (A) 0.1 0.01 $T_{J(MAX)} = 150$ °C $T_A = 25^{\circ}C$ Single Pulse 0.001 0.1 Fig. 12 SOA, Safe Operation Area



Typical Characteristics - P-CHANNEL





Typical Characteristics - P-CHANNEL (Cont.)

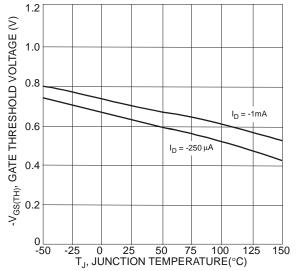
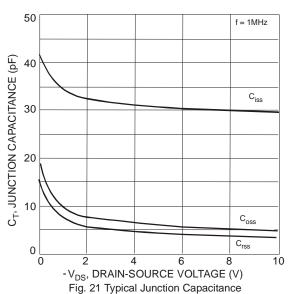
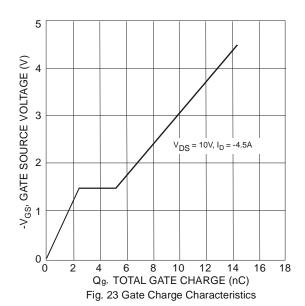
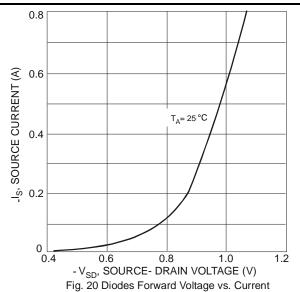
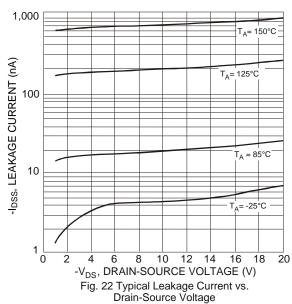


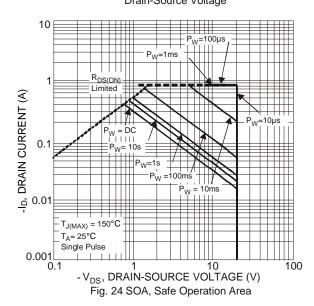
Fig. 19 Gate Threshold Variation vs. Ambient Temperature



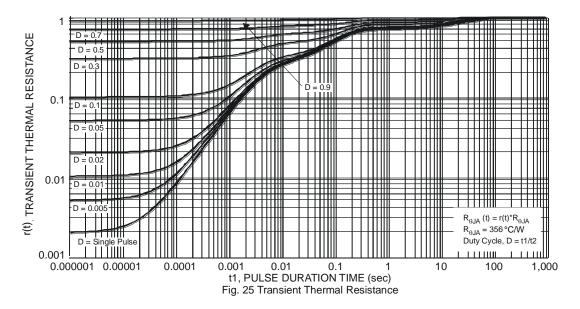








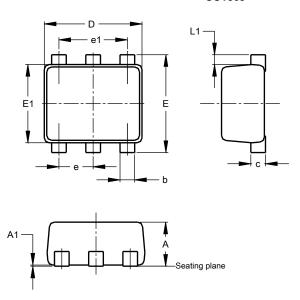




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT963



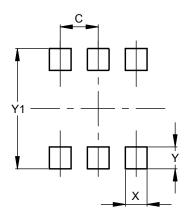
SOT963							
Dim	Min	Max	Тур				
Α	0.40	0.50	0.45				
A1	0.00	0.05					
b	0.10	0.20	0.15				
С	0.120	0.180	0.150				
D	0.95	1.05	1.00				
Е	0.95	1.05	1.00				
E1	0.75	0.85	0.80				
е			0.35				
e1	-		0.70				
L1	0.05	0.15	0.10				
All Dimensions in mm							



Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT963



Dimensions	Value (in mm)
С	0.350
Х	0.200
Υ	0.200
Y1	1.100

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 - 2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.
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DMC2990UDJQ
Document number: DS39168 Rev. 1 - 2

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